

## **MOSFET**

#### OptiMOS<sup>™</sup> 7 Power-Transistor, 15 V

#### **Features**

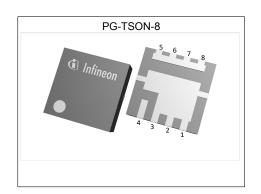
- N-channel, logic level
- Very low on-resistance R<sub>DS(on)</sub>
  Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliantHalogen-free according to IEC61249-2-21
- Optimized for high performance SMPS, e.g. synchronous rectification

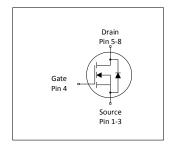
#### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

Table 1 1to j 1 of 101111 and 100 to an annother								
Parameter	Value	Unit						
<b>V</b> <sub>DS</sub>	15	V						
R <sub>DS(on),max</sub>	0.45	mΩ						
I <sub>D</sub>	379	A						
Qoss	27	nC						
Q <sub>G</sub>	29	nC						











Type / Ordering Code	Package	Marking	Related Links
IQE004NE1LM7	PG-TSON-8	004E1L7	-

# OptiMOS<sup>™</sup> 7 Power-Transistor, 15 V



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## OptiMOS<sup>™</sup> 7 Power-Transistor, 15 V IQE004NE1LM7



## 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Damanastan	O h l		Value	S		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	379 240 58	A	V <sub>GS</sub> =7 V, T <sub>C</sub> =25 °C V <sub>GS</sub> =7 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =7 V, T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1516	Α	<i>T</i> <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	859	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$
Recommended gate source voltage	V <sub>GS</sub>	-7	-	7	V	-
Gate source voltage, transient	V <sub>GS,AC</sub>	-8	-	8	V	t <sub>pulse</sub> <20 ns
Power dissipation	P <sub>tot</sub>	-	-	89 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>2)</sup>
Operating and storage temperature $T_{\rm j}$ , $T_{\rm stg}$		-55	-	150	°C	-

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	1.4	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>5)</sup>	R <sub>thJA</sub>	-	-	60	°C/W	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for source connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

<sup>&</sup>lt;sup>5)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for connection. PCB is vertical in still air.

## OptiMOS<sup>™</sup> 7 Power-Transistor, 15 V IQE004NE1LM7



#### 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Barranatan	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	15	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.2	1.6	2.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 432  \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =12 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =12 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	$I_{\mathrm{GSS}}$	-	10	100	nA	V <sub>GS</sub> =7 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.37 0.47	0.45 0.57	mΩ	V <sub>GS</sub> =7 V, I <sub>D</sub> =30 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =20 A
Gate resistance	R <sub>G</sub>	-	0.4	-	Ω	-
Transconductance	<b>g</b> fs	85	170	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 30 A$

Table 5 Dynamic characteristics

Devementar	Comphal	Values			11:4	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	4800	6240	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =7.5 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	2600	3380	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =7.5 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	260	455	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =7.5 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	9	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	2	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	21	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	4	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Davamatav	Comple at	Values			11:4	Nata / Tast Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge <sup>1)</sup>	Q <sub>gs</sub>	-	13	18.8	nC	$V_{DD}$ =7.5 V, $I_{D}$ =30 A, $V_{GS}$ =0 to 4.5 V
Gate charge at threshold <sup>1)</sup>	Q <sub>g(th)</sub>	-	7.6	11	nC	$V_{DD}$ =7.5 V, $I_{D}$ =30 A, $V_{GS}$ =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	5.7	8.5	nC	$V_{DD}$ =7.5 V, $I_{D}$ =30 A, $V_{GS}$ =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	11.1	-	nC	$V_{DD}$ =7.5 V, $I_{D}$ =30 A, $V_{GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	29	36	nC	$V_{DD}$ =7.5 V, $I_{D}$ =30 A, $V_{GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.7	-	V	$V_{DD}$ =7.5 V, $I_{D}$ =30 A, $V_{GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	44	55	nC	$V_{\rm DD}$ =7.5 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 7 V
Output charge <sup>1)</sup>	Qoss	-	27	36	nC	V <sub>DS</sub> =7.5 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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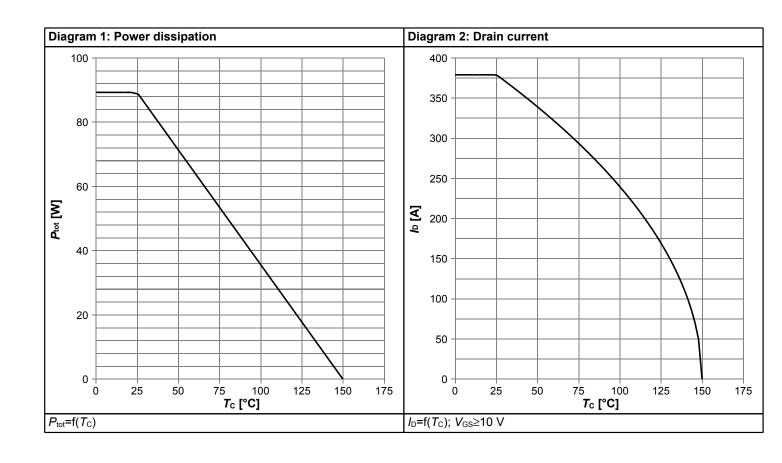


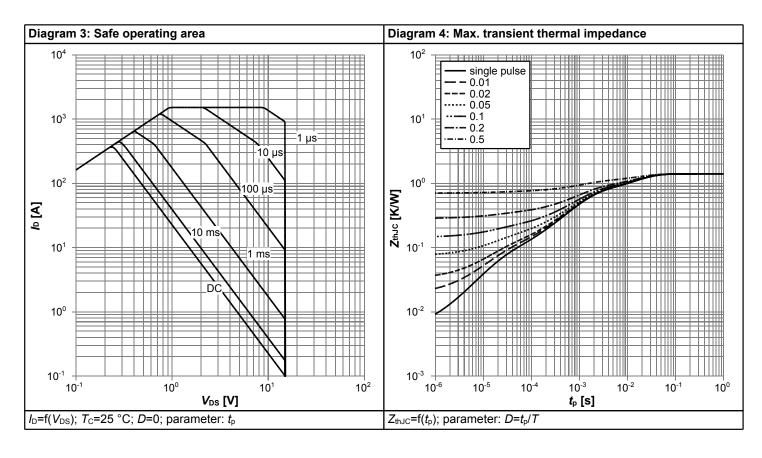
#### Table 7 Reverse diode

Davamatav	Cumbal		Values			Nata / Tank Canadikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I <sub>S</sub>	-	-	87	Α	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	1516	Α	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.76	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =30 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	31	62	ns	$V_R$ =7.5 V, $I_F$ =30 A, $di_F/dt$ =100 A/ $\mu$ s
Reverse recovery charge <sup>1)</sup>	Qrr	-	24	48	nC	$V_R$ =7.5 V, $I_F$ =30 A, $di_F/dt$ =100 A/ $\mu$ s
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	25	50	ns	$V_R$ =7.5 V, $I_F$ =30 A, $di_F/dt$ =300 A/ $\mu$ s
Reverse recovery charge <sup>1)</sup>	Qrr	-	49	98	nC	V <sub>R</sub> =7.5 V, I <sub>F</sub> =30 A, di <sub>F</sub> /dt=300 A/μs

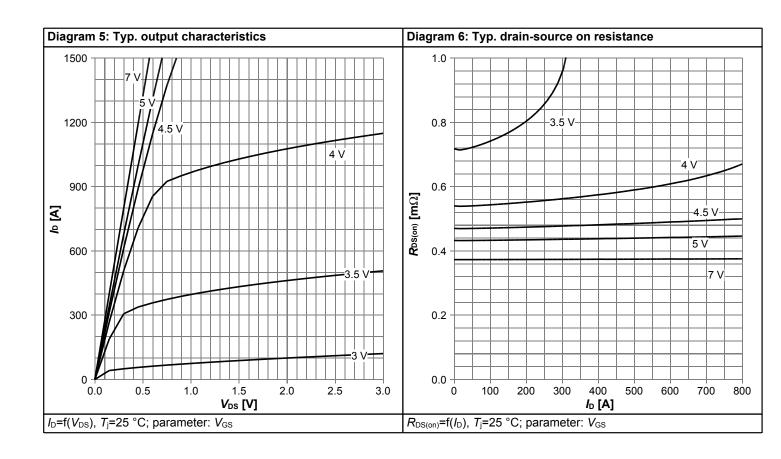


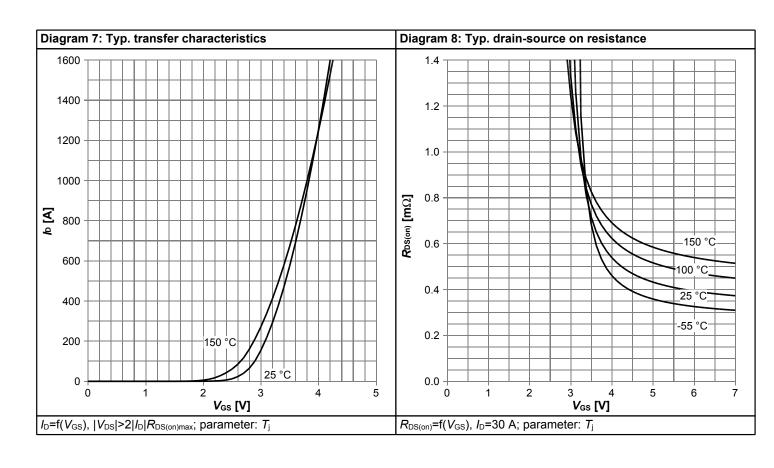
## 4 Electrical characteristics diagrams



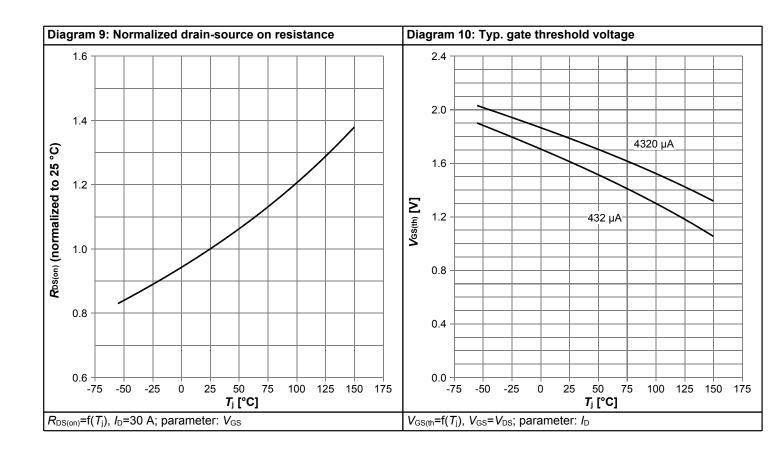


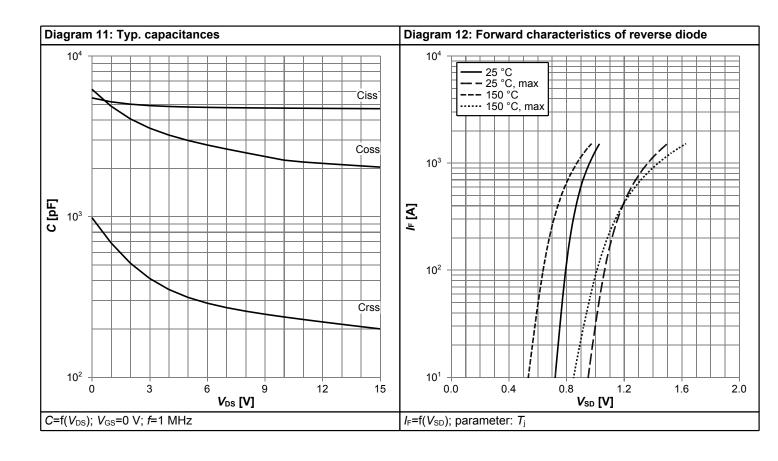




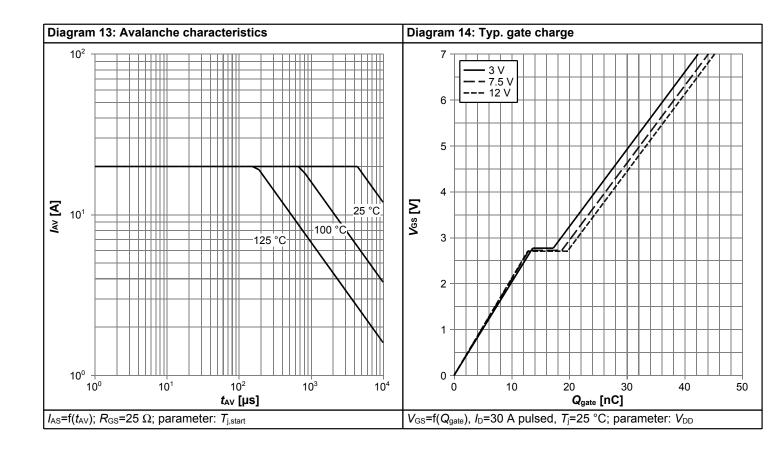


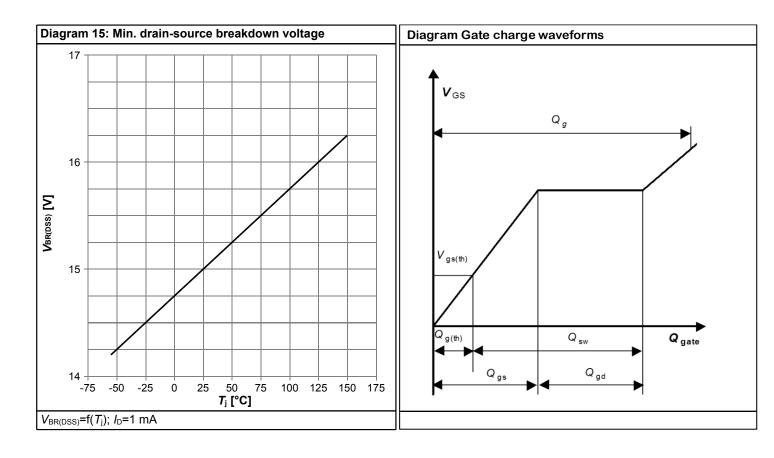






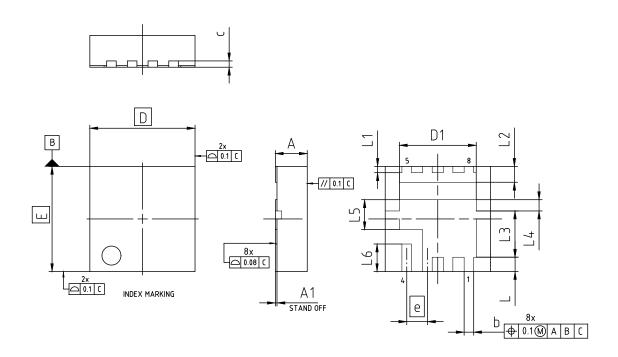








## 5 Package Outlines



DIMENSION	MILLIM	ETERS				
DIMENSION	MIN.	MAX.				
Α	-	1.10				
A1	-	0.05				
b	0.20	0.40				
С	0.20					
D	3.30					
D1	2.31	2.51				
E	3.30					
е	0.65					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.35	1.55				
L4	0.26 0.46					
L5	0.84 1.04					
L6	0.77	0.97				

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0 1 2mm			
EUROPEAN PROJECTION			
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Figure 1 Outline PG-TSON-8, dimensions in mm

## OptiMOS<sup>™</sup> 7 Power-Transistor, 15 V IQE004NE1LM7



#### **Revision History**

IQE004NE1LM7

Revision: 2023-07-25, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2023-07-25	Release of final version				

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